WAKEFIELDTHERMAL

HiBay LED Heat Sink

Wakefield-Vette's HiBay LED Heat Sink is the optimal choice for any of the industries LED array's that require a natural convection cooling method.

The unique mounting puck allows for machining patterns for historical, current, and future LED Module Hole Patterns for manufacturers such as Bridgelux, Cree, Dialight, Lumileds, etc.

The HiBay Series is available in different lengths as well as pre-machined for your specific array.

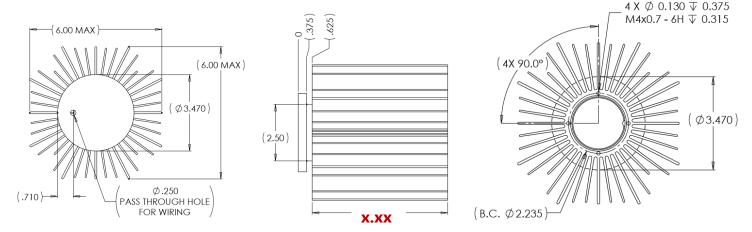
Part Number	x.xx Length Dimension (in.)
124212	6
124213	8
124214	10
124215	12

*Other Lengths Available Upon Request

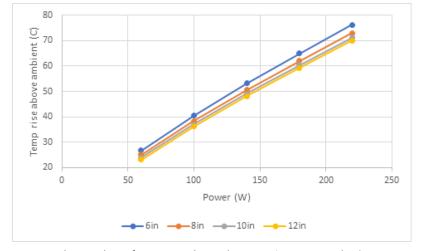




HiBay LED Heat Sink Assembly are identical with the exception of the overall extrusion length as identified with the x.xx dimension.



Thermal Performance



*Thermal Performance based on a 40mm LED device.



Contact Wakefield-Vette for Custom Machining Patterns

Thermal Cooling Solutions from Smart to Finish

DUAL LED Heat Sink- Active & Passive w/ Fan Attachment

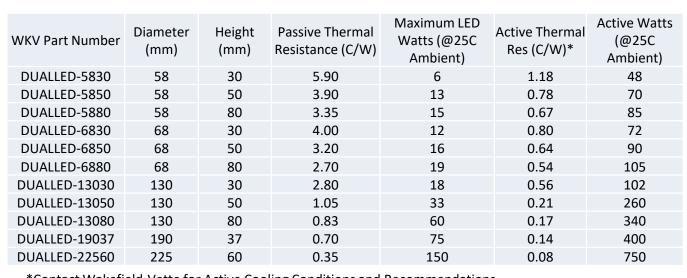
Wakefield- Vette's DUAL LED Series heat sinks are extremely versatile for a customer's application whether they require either an active or passive solutions. Each DUAL LED Heat Sink has a built-in option which lets the customer add a standard, silent fan in less than a minute, with just four screws, and get more than a *five-times improvement* in thermal resistance and wattage rating up to 750 watts.





Features:

- Single-Piece Forged-Aluminum Construction For Low Thermal Resistance & Compact Form-Factor
- Eleven Models Ranging from 58 mm to 225 mm Diameter with Thermal Resistance As Low As 0.35 Deg C/W For Passive Cooling up to 150 Watts
- Compatible with all SMD LED arrays, COBs, and "Driverless"
 AC-LED's From All Major LED manufacturers



^{*}Contact Wakefield-Vette for Active Cooling Conditions and Recommendations

See following pages for High Performance Active Solutions

DUAL LED Heat Sink- Active & Passive w/ Fan Attachment

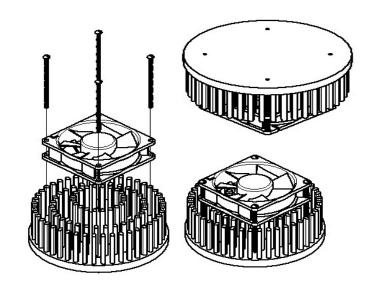


All DUAL LED heatsinks have pre-drilled and tapped holes in the baseplate so that a fan can be attached to the pin side (blowing air into the pins) with just four 6-62 screws of proper length (or longer screws with appropriate washers or spacers. Wakefield-Vette lists the DUAL LED heat sinks and suggested fan type to achieve silent operation and life expectancy approaching 100,000 hours. Please note that we recommend fans with dual-ball-bearing and DC brushless type motors.

For Use in Active Cooling Mode...

The heat sinks are manufactured to accept four 6-32 screws, which can be inserted through the four fanmounting holes and into the four tapped holes in the baseplate. Fan power to achieve the rated thermal resistance should be < 1 Watt. Please contact Wakefield-Vette to discuss power supply and fan options.

Please take into consideration the heat sink total height and fan thickness when selecting the length of 6-32 screws to be used. If slightly longer screws are purposely used to ensure extension beyond the heat sink baseplate (>1/4"), then standard 6-32 hex standoffs can be employed to enable a variety of enclosure attachment/mounting methods.

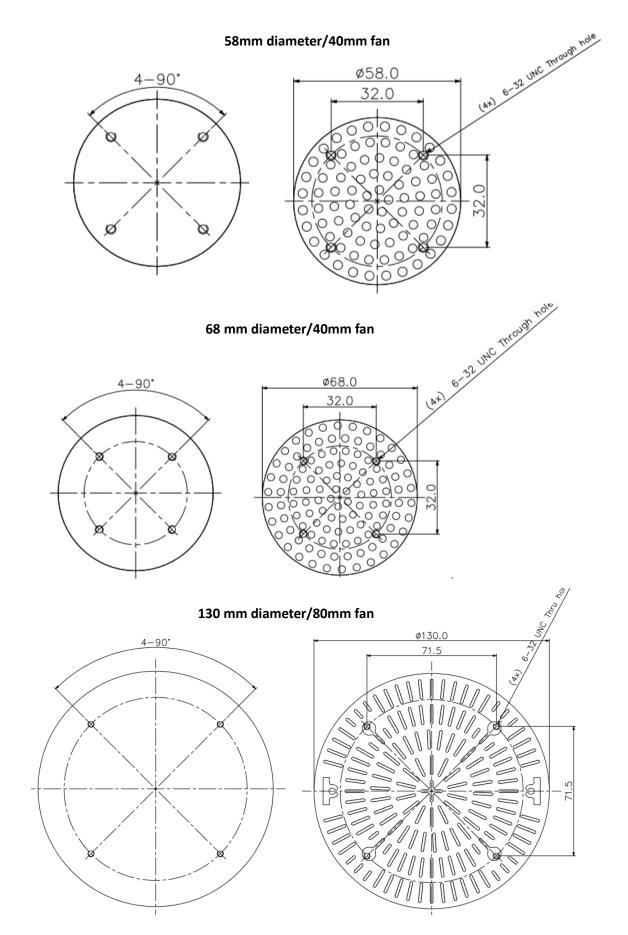


Recommended hardware for fan mounting in active-cooling mode:

WKV Part Number	Diameter (mm)	Height (mm)	Base Thickness (mm)	Fan Diameter (mm)	Active Thermal Res (C/W)*	Active Watts (@25C Ambient)
DUALLED-5830	58	30	5	40	1.18	48
DUALLED-5850	58	50	5	40	0.78	70
DUALLED-5880	58	80	5	40	0.67	85
DUALLED-6830	68	30	5	40	0.80	72
DUALLED-6850	68	50	5	40	0.64	90
DUALLED-6880	68	80	5	40	0.54	105
DUALLED-13030	130	30	10	80	0.56	102
DUALLED-13050	130	50	10	80	0.21	260
DUALLED-13080	130	80	10	80	0.17	340
DUALLED-19037	190	37	5	120	0.14	400
DUALLED-22560	225	60	10	120	0.08	750

DUAL LED Heat Sink-Active & Passive w/ Fan Attachment

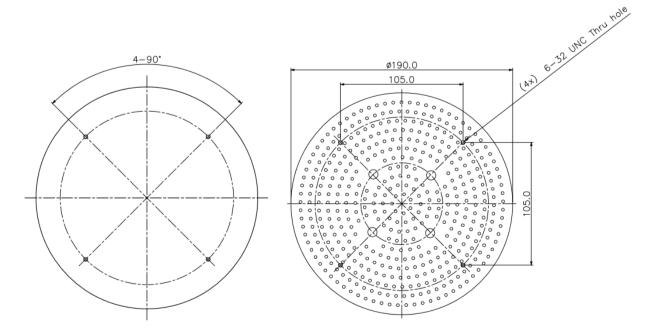
Fan-attachment -- Hole locations::



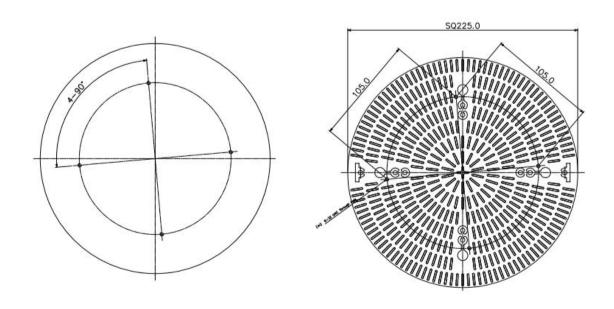
DUAL LED Heat Sink-Active & Passive w/ Fan Attachment

<u>Fan-attachment</u> — Hole locations (holes tapped for 6-32 thread:

190 mm diameter/120mm fan



225 mm diameter/120mm fan



Features:

- Thermal resistance range Rth(7.69 $^{\circ}$ C/W; 5.0 $^{\circ}$ C/W; 4.17 $^{\circ}$ C/W).
- Radial design with mounting holes foreseen for direct mounting of a wide range of LED modules and COB's: Diameter 48mm -110mm
- Extruded from highly conductive aluminum.
- Black anodized



Compatible with:

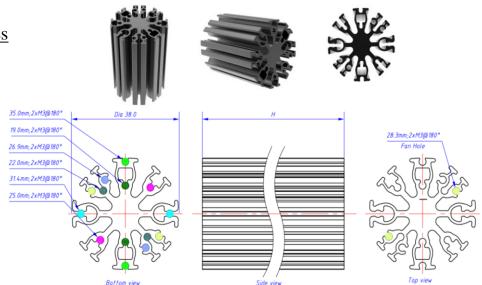
- Xicato XSM, XIM,XTM;
- Bridgelux ESS, ESR, Vero 10, Vero 13, Vero 18 V-series;
- Citizen CLL022-CLU024, CLL032-CLU034;
- Cree XLamp CXA13xx, CXA15xx, CSA18xx;
- Lumileds Luxeon COB's 1203, 1204, 1205, Luxeon K arrays K12, K16;
- Osram PrevaLED Core, SOLERIQ P and SOLERIQ S LED engines.
- Seoul Semiconductor ZC6, ZC12, ZC18, ZC25;
- Tridonic TALEXXmodule SLE modules;
- LG Innotek LEMWM18 10W, 13W, 17W
- Edison EdiLex SLM and EdiLex II COB LED engines.
- Lustrous LUSTRON 6 series LL604F, LL608D, LL613F, LL620F
- Prolight Opto PABS, PABA, PACB, PANA
- Samung LC013,LC019,LC026 COB LED engines.
- SHARP Mini Zenigata Intermo and Mega Zenigata LED engines.
- Philips Fortimo SLM LED engines.
- Vossloh-Schwabe LUGA Shop LED engines.
- Luminus C##9,C##14 LED engines.

38mm Diameter

						Thermal Resistance (
WKV Part Number	Description	Height (mm)	Diameter (mm)	Max. Lumen (Im)	Dissipated Power (W)	°C/W)	Weight (g)
FLOWLED-3820	Flow LED Heat Sink 38MM DIA 20H	20	38	630	4.5	7	24
FLOWLED-3850	Flow LED Heat Sink 38MM DIA 50H	50	38	980	7	11.4	60.9

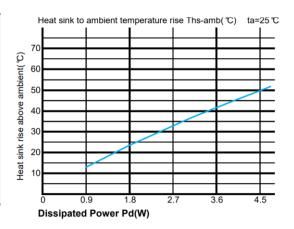
*Note: All Bases Have no Holes

No.	Finish	Mounting hole
A1		19.0mm;2xM3@180°
A2		22.0mm;2xM3@180°
А3		25.0mm;2xM3@180°
A4		26.9mm;2xM3@180°
A5		28.3mm;2xM3@180°
A6	0	31.4mm;2xM3@180°
A7	•	35.0mm;2xM3@180°



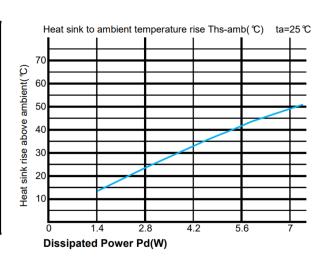
Thermal Data FLOWLED-3820

	= Pe x 1-ηL)	Heat sink to ambient thermal resistance - Rhs-amb (*C/W)	Heat sink to ambient temperature rise Ths-amb (°C)
П	0.9	15.4	14
(W)Pd	1.8	13.4	24.5
Dissipated Power Pd(W)	2.7	12.4	34
ated P	3.6	11.4	42
Dissip	4.5	10.9	50
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Thermal Data FLOWLED-3850

	= Pe x 1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (°C/W)	Heat sink to ambient temperature rise Ths-amb (°C)
	1.4	9.8	14
Pd(W)	2.8	8.4	24
Dissipated Power Pd(W)	4.2	7.7	33.2
ated P	5.6	7.2	41.6
Dissip	7	6.9	49.5

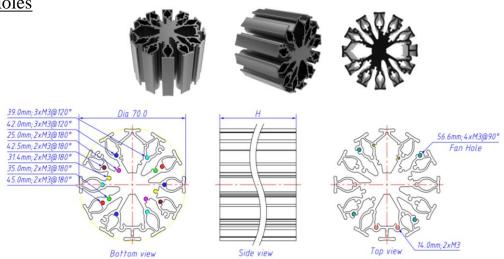


70mm Diameter

						Thermal Resistance (
WKV Part Number	Description	Height (mm)	Diameter (mm)	Max. Lumen (lm)	Dissipated Power (W)	°C/W)	Weight (g)
FLOWLED-7040	Flow LED Heat Sink 70MM DIA 40H	40	70	2700	19.6	2.3	183
FLOWLED-7080	Flow LED Heat Sink 70MM DIA 80H	80	70	3200	23	1.9	294

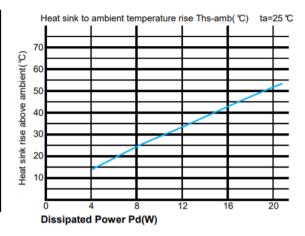
*Note: All Bases Have no Holes

No.	Finish	Mounting hole
A 1	•	25.0mm;2xM3@180°
A2		31.4mm;2xM3@180°
АЗ	•	35.0mm;2xM3@180°
A4		39.0mm;3xM3@120°
A5		42.0mm;3xM3@120°
A6		42.5mm;2xM3@180°
A7		45.0mm;2xM3@180°
A8		56.6mm;4xM3@90°
A9		14.0mm;2xM3
A10	•	18.3mm;2xM2



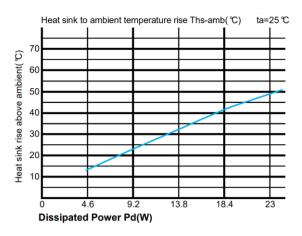
Thermal Data FLOWLED-7040

	= Pe x 1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (°C/W)	Heat sink to ambient temperature rise Ths-amb (℃)
	4	3.4	14.5
(M)Pc	8	2.9	25
Dissipated Power Pd(W)	12	2.6	34.4
ated P	16	2.5	43
Dissipa	20	2.3	51



Thermal Data FLOW

	Heat sink to ambient thermal resistance Rhs-amb (℃/W)		Heat sink to ambient temperature rise Ths-amb (で)
	4.6	2.8	14
Pd(W)	9.2	2.4	24
ower	13.8	2.2	33
ated P	18.4	2	41.5
Dissipated Power Pd(W)	23	1.9	49

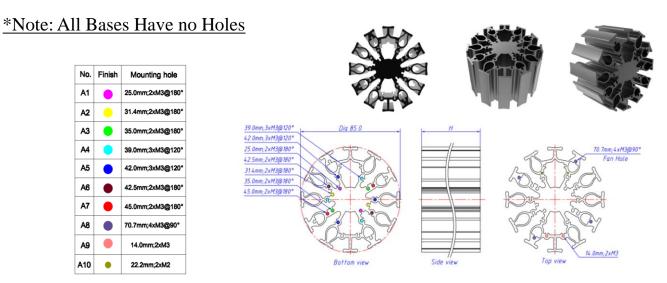


85mm Diameter

						Thermal Resistance (
WKV Part Number	Description	Height (mm)	Diameter (mm)	Max. Lumen (lm)	Dissipated Power (W)	°C/W)	Weight (g)
FLOWLED-8540	Flow LED Heat Sink 85MM DIA 40H	40	85	3600	26	1.9	249
FLOWLED-8560	Flow LED Heat Sink 85MM DIA 60H	60	85	4440	32	1.6	398

No. Finish Mounting hole 25.0mm;2xM3@180° Α1 31.4mm;2xM3@180° **A2** АЗ 35.0mm;2xM3@180° A4 39.0mm;3xM3@120° A5 42.0mm;3xM3@120° A6 42.5mm;2xM3@180° A7 45.0mm;2xM3@180° **A8** 70.7mm;4xM3@90° 14.0mm;2xM3

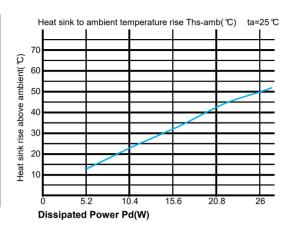
A10



Thermal Data FLOWLED-8540

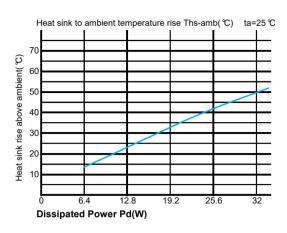
22.2mm;2xM2

	= Pe x 1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (*C/W)	Heat sink to ambient temperature rise Ths-amb (℃)
Г	5.2	2.5	14
Pd(W)	10.4	2.1	24
Dissipated Power Pd(W)	15.6	1.9	33
ated P	20.8	1.9	43.5
Dissip	26	1.7	50



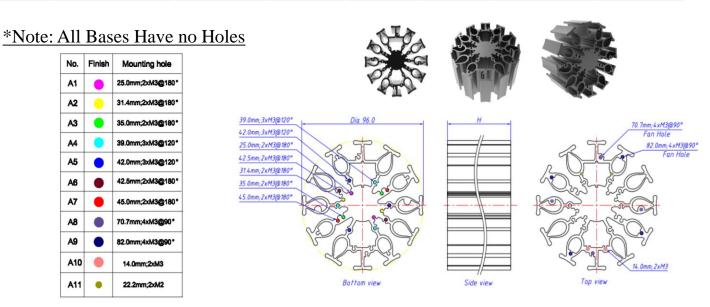
Thermal Data FLOWLED-8560

	= Pe x 1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (℃/W)	Heat sink to ambient temperature rise Ths-amb (℃)
		FanLED-8580	FanLED-8580
	6.4	2	14
(W)pc	12.8	1.7	24
ower	19.2	1.6	34
ated P	25.6 1.4		42
Dissipated Power Pd(W)	32	1.3	50



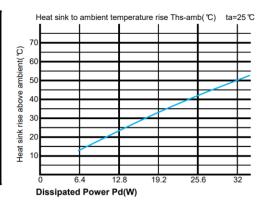
96mm Diameter

WKV Part Number	Description	Height (mm)	Diameter (mm)	Max. Lumen (lm)	Dissipated Power (W)	Thermal Resistance (°C/W)	Weight (g)
FLOWLED-9650	Flow LED Heat Sink 96MM DIA 50H	50	96	4400	32	1.5	312
FLOWLED-9680	Flow LED Heat Sink 96MM DIA 90H	80	96	5600	40	1.2	499



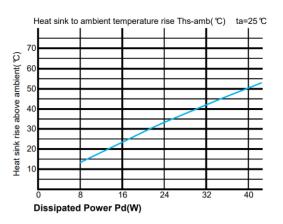
Thermal Data FLOWLED-9650

	= Pe x 1-ηL)	Heat sink to ambient thermal resistance . Rhs-amb (°C/W)	Heat sink to ambient temperature rise Ths-amb (°C)
П	6.4	1.9	14
(W)Pd	12.8	1.7	24
ower	19.2	1.5	33.5
ated P	25.6	1.4	42
Dissipated Power Pd(W)	32	1.3	50
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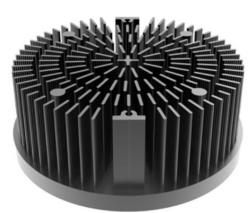
Thermal Data FLOWLED-9680

	= Pe x 1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (*C/W)	Heat sink to ambient temperature rise Ths-amb (で)
П	8	1.5	14
(W)Pc	16	1.3	24
ower	24	1.2	34
ated P	32	1.1	42
Dissipated Power Pd(W)	40	1.0	50



PADLED Heat Sink

Wakefield- Vette's PADLED is designed with 99.7% high-purity aluminum cold forging process. The design of the series is simple and gorgeous, and the blade is rectangular in a radial patern, which makes the convection heat dissipation reasonable. This heat sink also has 4 PCS holes on top. This i compatible with Light Modules such as Edison, Xicato, Bridgelux, Osram, Lumileds, Cree, Tridonic, LG, Lustrous, Prolight, Samsung, SHARP, Luminus and Philips.



Features:

- Mechanical compatibility with direct mounting of the LED modules to the LED cooler and thermal performance matching the lumen packages
- Side fins to be frilled M3 or M4 Hotles
- Several Diameters, Several Standard heights
- Forged from highly conductive aluminum
- Black Anodized
- Blank surface with no holes to mount any device listed below

Compatible with:

- Bridelux: Vero 18/22 Vero SE 18/29 LED engines;
- Cree: XLamp CXA 25xx, Xlamp CXB 25xx, CXA 30xx, Xlamp CXB 30xx LED en
- Citizen: CLU036, CLU038, CLU721, CLU711, CLU046, CLU048, CLU731 LED engines;
- Edison: EdiLex III COB LED engines;
- GE lighting: InfusionTM LED engines;
- LG Innotek: 32W, 42W, 56W LED engines;
- LumiLEDS: LUXEON 1211, LUXEON 1216, LUXEON 1812, LUXEON 1825 LED eng
- Lumens: Ergon-COB-2530, 2540, 3050, 3070 LED engines;
- Luminus: CXM-18, CLM-22, CXM-22 LED engines;
- Nichia: NFCWL036B, NFCLL036B, NFCWL060B, NFCLL060B LED engines;
- Osram: SOLERIQ® S 19, Core series LED engines;
- Philips: Fortimo SLM LED engines;
- Prolight Opto: PABS, PABA, PACB, PANA LED engines;
- Samsung: LC026B, LC033B, LC040B, LC040D, LC060D, LC080D LED engines;
- Seoul Semiconductor: Acrich MJT COBs, DC COB LED engines;
- Tridonic: SLE G6 19mm, SLE G6 23mm LED engines;
- Vossloh-Schwabe: LUGA Shop and LUGA C LED engines;
- Xicato: XSM, XIM, XTM LED engines;

PADED Heat Sink

130mm Diameter

WKV Part		Height	Diameter	Max. Lumen	Dissipated Power	Thermal Resistance (
Number	Description	(mm)	(mm)	(lm)	(W)	°C/W)	Weight (g)
PADLED-13080	PAD LED Heat Sink 130MM DIA 80H	80	130	4600	33	1.5	492
PADLED-130100	PAD LED Heat Sink 130MM DIA 100H	100	130	6700	48	1	625

*Note: All Bases Have no Holes

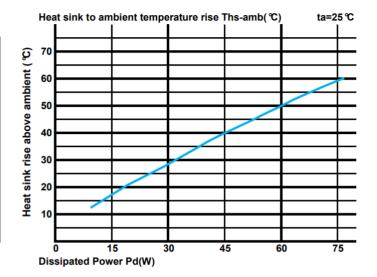






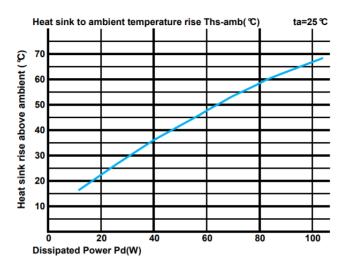
Thermal Data PADLED-13080

	= Pe x -ηL)	Heat sink to ambient thermal resistance Rhs-amb (°C/W)	Heat sink to ambient temperature riseThs-amb (℃)		
(W)	15.0	1.13	17.0		
er Pd(30.0	0.93	28.0		
Dissipated Power Pd(W)	45.0	0.89	40.0		
sipate	60.0	0.83	50.0		
Dis	75.0	0.77	58.0		



Thermal Data PADLED-130100

	= Pe x -ηL)	Heat sink to ambient thermal resistance Rhs-amb (℃/W)	Heat sink to ambient temperature rise Ths-amb (℃)		
(W)	20.0	1.10	22.0		
er Pd(40.0	0.90	36.0		
d Pow	60.0	0.78	47.0		
Dissipated Power Pd(W)	80.0 0.73		58.0		
	100.0	0.66	66.0		



PADED Heat Sink

165mm Diameter

						Thermal Resistance (
WKV Part Number	Description	Height (mm)	Diameter (mm)	Max. Lumen (lm)	Dissipated Power (W)	°C/W)	Weight (g)
PADLED-16580	PAD LED Heat Sink 165MM DIA 80H	80	165	15000	95	0.52	1550
PADLED-165100	PAD LED Heat Sink 165MM DIA 100H	100	165	16800	120	0.4	1700

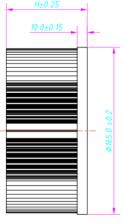
*Note: All Bases Have no Holes





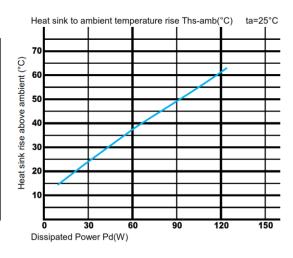


Ø 155.0	
Ø145.0	•
ø113.0	



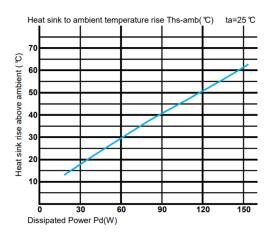
Thermal Data PADLED-16580

= Pe x -ηL)	Heat sink to ambient thermal resistance Rhs-amb (°C/W)	Heat sink to ambient temperature rise Ths-amb (°C)
30.0	0.78	23.5
60.0	0.63	38.0
90.0	0.52	47.0
120.0	0.51	61.0
150.0	0.49	73.0
	30.0 60.0 90.0	thermal resistance Rhs-amb (*C/W) 30.0 0.78 60.0 0.63 90.0 0.52



Thermal Data PADLED-165100

	= Pe x -ηL)	Heat sink to ambient thermal resistance Rhs-amb (°C/W)	Heat sink to ambient temperature rise Ths-amb (°C)
s ·	30.0	0.60	18.0
er Pd(V	60.0	0.48	29.0
Dissipated Power Pd(W)	90.0	0.44	40.0
ssipate	120.0	0.42	50.0
ä	150.0	0.41	61.0



PADED Heat Sink

225mm Diameter

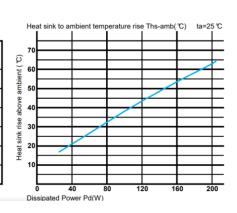
						Thermal	
WKV Part		Height	Diameter			Resistance	
Number	Description	(mm)	(mm)	Max. Lumen (lm)	Dissipated Power (W)	(°C/W)	Weight (g)
PADLED-22560	PAD LED Heat Sink 225MM DIA 60H	60	225	21000	150	0.3	2220
PADLED-225100	PAD LED Heat Sink 225MM DIA 100H	100	225	28000	200	0.2	3150

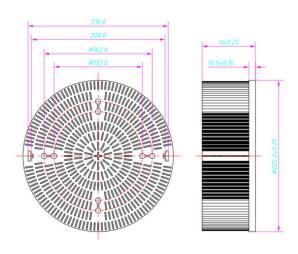
*Note: All Bases Have no Holes



Thermal Data PADLED-22560

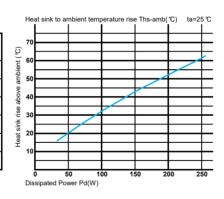
	I = Pe x (1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (*C/W)	: Heat sink to ambient temperature rise Ths-amb (°C)
S	40.0	0.53	21.0
Pd(V	80.0	0.41	33.0
Dissipated Power Pd(W)	120.0	0.37	44.0
ssipate	160.0	0.33	53.0
Ö	200.0	0.32	63.0

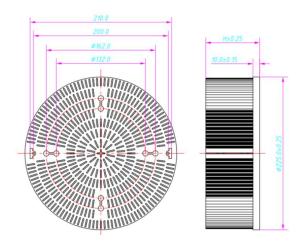




Thermal Data PADLED-225100

Pd = Pe x (1-ηL)		Heat sink to ambient thermal resistance Rhs-amb (°C/W)	Heat sink to ambient temperature rise Ths-amb (℃)
۸)	50.0	0.40	20.0
er Pd(V	100.0	0.32	32.0
wod ba	150.0	0.29	43.0
Dissipated Power Pd(W)	200.0	0.26	52.0
250.0		0.24	61.0





Wakefield- Vette's PinLED is designed with 99.7% high-purity aluminum cold forging process. The design of the series is simple and gorgeous, and the blade is cylindrical, which makes the convection heat dissipation reasonable. This is compatible with Light Modules such as Edison, Xicato, Bridgelux, Osram, Lumileds, Cree, Tridonic, LG, Lustrous, Prolight, Samsung, SHARP, Luminus and Philips.

Features:

- Mechanical compatibility with direct mounting of the LED modules to the LED cooler and thermal performance matching the lumen packages
- Several Diameters, Several Standard heights
- Forged from highly conductive aluminum
- Black Anodized
- Blank surface with no holes to mount any device listed below





Compatible with:

- Xicato XSM, XIM,XTM
- Bridgelux ESS, ESR, Vero 10, Vero 13, Vero 18 V-series
 - Citizen CLL024-CLU028, CLL034-CLU038
 - Cree XLamp CXA13xx, CXA15xx, CSA18xx
- Lumileds Luxeon COB's 1203, 1204, 1205, Luxeon K arrays K12, K16
 - Osram PrevaLED Core, SOLERIQ P and SOLERIQ S LED engines
 - Seoul Semiconductor ZC6, ZC12, ZC18, ZC25
 - Tridonic TALEXXmodule SLE modules
 - LG Innotek LEMWM18 10W, 13W, 17W
 - Edison EdiLex SLM and EdiLex II COB LED engines
 - Lustrous LUSTRON 6 series LL604F, LL608D, LL613F, LL620F
 - Prolight Opto PABS, PABA, PACB, PANA
 - Samung LC013, LC019, LC026 COB LED engines
 - SHARP Mini Zenigata Intermo and Mega Zenigata LED engines
 - Philips Fortimo SLM LED engines
 - Vossloh-Schwabe LUGA Shop LED engines
 - Luminus C##9, C##14 LED engines

www.wakefield-vette.com

48mm Diameter

WKV Part		Height	Diameter	Max. Lumen	Dissipated Power	Thermal Resistance (
Number	Description	(mm)	(mm)	(lm)	(W)	°C/W)	Weight (g)
PINLED-4830	Pin LED Heat Sink 48MM DIA 30H	30	48	1100	8	6.25	46
PINLED-4850	Pin LED Heat Sink 48MM DIA 50H	50	48	1400	10	5	64

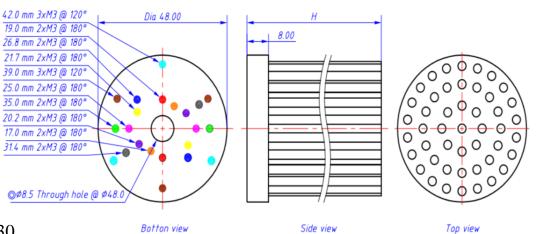
*Note: All Bases Have no Holes

No.	Finish	Mounting Hole
A1	•	17.0 mm 2xM3 @ 180°
A2		19.0 mm 2xM3 @ 180°
АЗ		20.2 mm 2xM3 @ 180°
A4	0	21.7 mm 2xM3 @ 180°
A5		25.0 mm 2xM3 @ 180°
A6		26.8 mm 2xM3 @ 180°
A7		31.4 mm 2xM3 @ 180°
A8	•	35.0 mm 2xM3 @ 180°
A9		39.0 mm 3xM3 @ 120°
A10		42.0 mm 3xM3 @ 120°
A11		@ Ø8.5 Through hole @ Ø48.0



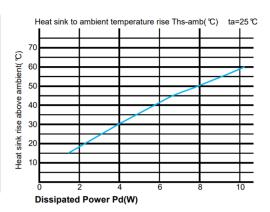




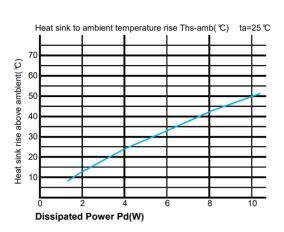


Thermal Data PINLED-4830

Pd = Pe x (1-ηL)		Heat sink to ambient thermal resistance Rhs-amb (℃/W)	Heat sink to ambient temperature rise Ths-amb (°C)
	2	9	18
Pd(W)	4	7.5	30
Dissipated Power Pd(W)	6	7	42
ated P	8	6.25	50
Dissip	10	5.9	59



	= Pe x 1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (*C/W)	Heat sink to ambient temperature rise Ths-amb (°C)	
	2	7	14	
Pd(W)	4	6.25	25	
Dissipated Power Pd(W)	6	5.67	34	
ated P	8	5.38	43	
Dissip	10	5	50	

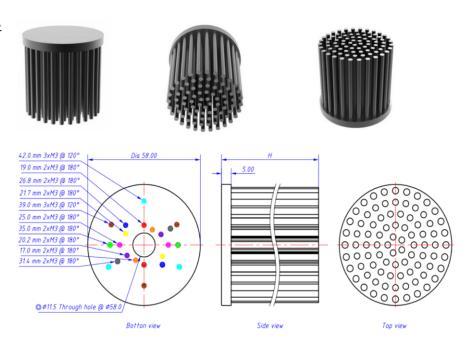


58mm Diameter

WKV Part		Height	Diameter	Max. Lumen	Dissipated Power	Thermal Resistance (
Number	Description	(mm)	(mm)	(lm)	(W)	°C/W)	Weight (g)
PINLED-5830	Pin LED Heat Sink 58MM DIA 30H	30	58	1400	10	5	79
PINLED-5850	Pin LED Heat Sink 58MM DIA 50H	50	58	1800	13	3.85	108

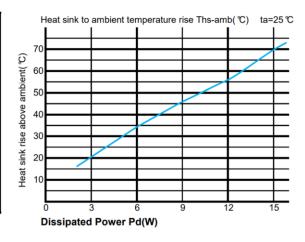
*Note: All Bases Have no Holes

No.	Finish	Mounting Hole
A1		17.0 mm 2xM3 @ 180°
A2		19.0 mm 2xM3 @ 180°
A3		20.2 mm 2xM3 @ 180°
A4	0	21.7 mm 2xM3 @ 180°
A5		25.0 mm 2xM3 @ 180°
A6		26.8 mm 2xM3 @ 180°
A7		31.4 mm 2xM3 @ 180°
A8	-	35.0 mm 2xM3 @ 180°
A9		39.0 mm 3xM3 @ 120°
A10		42.0 mm 3xM3 @ 120°
A11		

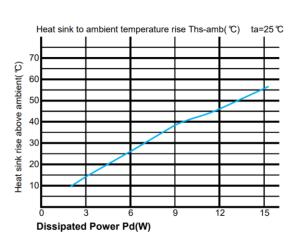


Thermal Data PINLED-5830

	= Pe x 1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (℃/W)	Heat sink to ambient temperature rise Ths-amb (℃)	
П	3	6.67	20	
(W)pc	6	5.83	35	
Dissipated Power Pd(W)	9	5.11	46	
ated P	12	4.75	57	
Dissip	15	4.67	70	
L	·			



	= Pe x 1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (*C/W)	Heat sink to ambient temperature rise Ths-amb (°C)	
П	3	5	15	
(M)pc	6	4.67	26	
ower	9	4.33	39	
ated P	12	4	46	
Dissipated Power Pd(W)	15	3.8	57	

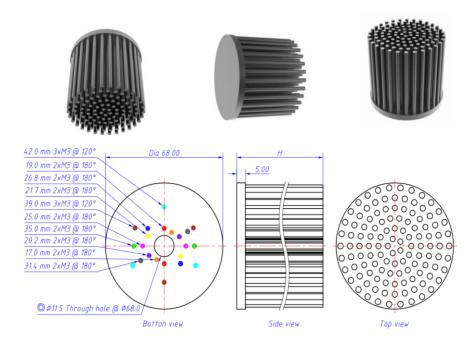


68mm Diameter

						Thermal	
WKV Part		Height	Diameter			Resistance	
Number	Description	(mm)	(mm)	Max. Lumen (Im)	Dissipated Power (W)	(°C/W)	Weight (g)
PINLED-6830	Pin LED Heat Sink 68MM DIA 30H	30	68	1900	12.5	4	77
PINLED-6860	Pin LED Heat Sink 68MM DIA 60H	60	68	2800	15.5	3.23	192

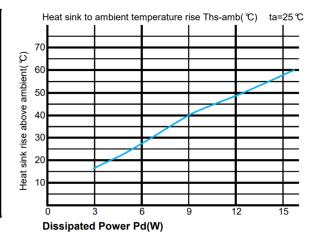
*Note: All Bases Have no Holes

No.	Finish	Mounting Hole
A1		17.0 mm 2xM3 @ 180°
A2	•	19.0 mm 2xM3 @ 180°
A3		20.2 mm 2xM3 @ 180°
A4	0	21.7 mm 2xM3 @ 180°
A5	0	25.0 mm 2xM3 @ 180°
A6		26.8 mm 2xM3 @ 180°
A7	•	29.7 mm 2xM3 @ 180°
A8	•	31.4 mm 2xM3 @ 180°
A9	•	35.0 mm 2xM3 @ 180°
A10		39.0 mm 3xM3 @ 120°
A11		42.0 mm 3xM3 @ 120°
A12		© Ø11.5 Through hole @ Ø68.0

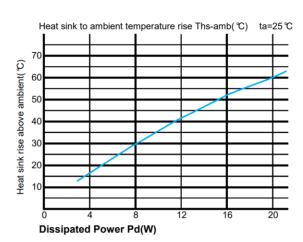


Thermal Data PINLED-6830

	= Pe x 1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (*C/W)	Heat sink to ambient temperature rise Ths-amb (°C)
	3	5.67	17
(W)pc	6	4.67	28
Dissipated Power Pd(W)	9	4.44	40
ated P	12	4.08	49
Dissip	15	3.87	58



	= Pe x 1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (°C/W)	Heat sink to ambient temperature rise Ths-amb (で)
	4	4.25	17
(M)pc	8	3.75	30
ower	12	3.42	41
ated P	16	3.25	52
Dissipated Power Pd(W)	20	3	60

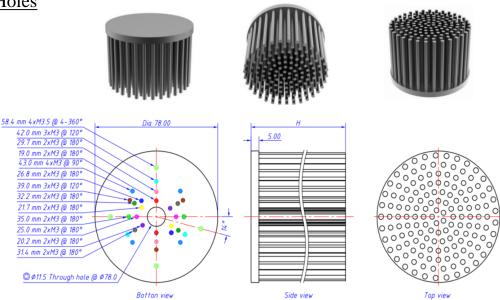


78mm Diameter

WKV Part		Height	Diameter			Thermal Resistance	
Number	Description	(mm)	(mm)	Max. Lumen (lm)	Dissipated Power (W)	(°C/W)	Weight (g)
PINLED-7830	Pin LED Heat Sink 78MM DIA 30H	30	78	2300	16.5	3.03	138
PINLED-7850	Pin LED Heat Sink 78MM DIA 50H	50	78	2900	21.5	2.33	197

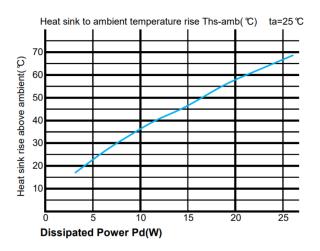
*Note: All Bases Have no Holes

No.	Finish	Mounting Hole
A1		17.0 mm 2xM3 @ 180°
A2		19.0 mm 2xM3 @ 180°
A3		20.2 mm 2xM3 @ 180°
A4	0	21.7 mm 2xM3 @ 180°
A5		25.0 mm 2xM3 @ 180°
A6		26.8 mm 2xM3 @ 180°
A7		29.7 mm 2xM3 @ 180°
A8	•	31.4 mm 2xM3 @ 180°
A9	•	32.2 mm 2xM3 @ 180°
A10	•	35.0 mm 2xM3 @ 180°
A11		39.0 mm 3xM3 @ 120°
A12		42.0 mm 3xM3 @ 120°
A13		43.0 mm 4xM3 @ 90°
A14		58.4 mm 4xM3.5 @ 4-360°
A15		© Ø11.5 Through hole @ Ø78.0

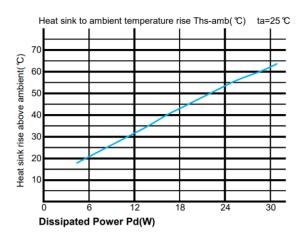


Thermal Data PINLED-7830

	= Pe x 1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (℃/W)	Heat sink to ambient temperature rise Ths-amb (℃)
	5	4.8	24
(W)pc	10	3.6	36
ower F	15	3.13	47
ated P	20	2.95	59
Dissipated Power Pd(W)	25	2.72	68



	= Pe x 1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (*C/W)	Heat sink to ambient temperature rise Ths-amb (°C)
П	6	3.5	21
(M)pc	12	2.67	32
ower	18	2.44	44
ated P	24	2.25	54
Dissipated Power Pd(W)	32	1.97	63



Features:

- Thermal resistance range Rth $(7.69^{\circ}\text{C/W}; 5.0^{\circ}\text{C/W}; 4.17^{\circ}\text{C/W})$.
- Modular design with mounting holes foreseen for direct mounting of LED modules and COB's: Diameter 48mm -110mm
- Extruded from highly conductive aluminum
- Black anodized



Compatible with:

- Xicato XSM, XIM, XTM;
- Bridgelux ESS, ESR, Vero 10, Vero 13, Vero 18 V-series;
- Citizen CLL022-CLU024, CLL032-CLU034;
- Cree XLamp CXA13xx, CXA15xx, CSA18xx;
- Lumileds Luxeon COB's 1203, 1204, 1205, Luxeon K arrays K12, K16;
- Osram PrevaLED Core, SOLERIQ P and SOLERIQ S LED engines.
- Seoul Semiconductor ZC6, ZC12, ZC18, ZC25;
- Tridonic TALEXXmodule SLE modules;
- LG Innotek LEMWM18 10W, 13W, 17W
- Edison EdiLex SLM and EdiLex II COB LED engines.
- Lustrous LUSTRON 6 series LL604F, LL608D, LL613F, LL620F
- Prolight Opto PABS, PABA, PACB, PANA
- Samung LC013, LC019, LC026 COB LED engines.
- SHARP Mini Zenigata Intermo and Mega Zenigata LED engines.
- Philips Fortimo SLM LED engines.
- Vossloh-Schwabe LUGA Shop LED engines.
- Luminus C##9, C##14 LED engines.

48mm Diameter

WKV Part		Height	Diameter	Max. Lumen	Dissipated Power	Thermal Resistance (
Number	Description	(mm)	(mm)	(lm)	(W)	°C/W)	Weight (g)
SPIRLED-4850	SPIR LED Heat Sink 48MM DIA 50H	50	48	1400	10	5	134

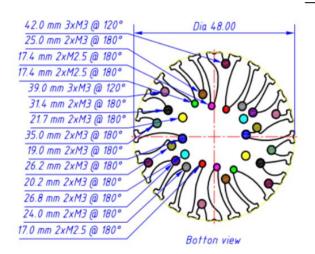
*Note: All Bases Have no Holes

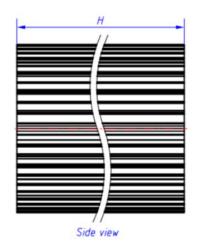
No.	Finish	Mounting Hole
H1	•	17.0 mm 2xM2.5 @ 180°
H2	0	17.4 mm 2xM2.5 @ 180°
НЗ	•	19.0 mm 2xM3 @ 180°
H4	•	20.2 mm 2xM3 @ 180°
H5	0	21.7 mm 2xM3 @ 180°
H6	•	22.0 mm 2xM2.5 @ 180°
H7	•	24.0 mm 2xM3 @ 180°
H8	•	25.0 mm 2xM3 @ 180°
H9	•	26.2 mm 2xM3 @ 180°
H10	•	26.8 mm 2xM3 @ 180°
H11	•	31.4 mm 2xM3 @ 180°
H12		35.0 mm 2xM3 @ 180°
H13		39.0 mm 3xM3 @ 120°
H14	•	42.0 mm 3xM3 @ 120°

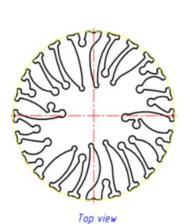






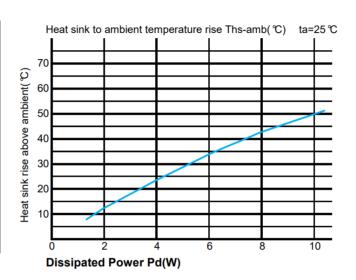






Thermal Data SPIRLED-4850

Pd (= Pe x 1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (*℃/W)	Heat sink to ambient temperature rise Ths-amb (℃)
	2	6.5	13
(W)pc	4	6	24
Dissipated Power Pd(W)	6	5.67	34
ated P	8	5.38	43
Dissip	10	5	50



70mm Diameter

WKV Part					Dissipated	Thermal Resistance	
Number	Description	Height (mm)	Diameter (mm)	Max. Lumen (lm)	Power (W)	(°C/W)	Weight (g)
SPIRLED-7050	SPIR LED Heat Sink 70MM DIA 50H	50	70	3200	22.9	2.2	192
SPIRLED-7080	SPIR LED Heat Sink 70MM DIA 80H	80	70	3900	28.1	1.8	308

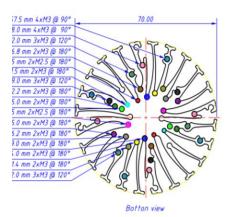
*Note: All Bases Have no Holes

_	_	
No.	Finish	Mounting Hole
H1	•	17.5 mm 2xM2.5 @ 180°
H2	•	18.5 mm 2xM2.5 @ 180°
НЗ	•	19.0 mm 2xM3 @ 180°
H4	•	21.5 mm 2xM3 @ 180°
H5	•	24.0 mm 2xM3 @ 180°
H6	•	25.0 mm 2xM3 @ 180°
H7	•	26.2 mm 2xM3 @ 180°
Н8	•	26.8 mm 2xM3 @ 180°
H9	•	31.4 mm 2xM3 @ 180°
H10	•	32.2 mm 2xM3 @ 180°
H11	•	35.0 mm 2xM3 @ 180°
H12	•	39.0 mm 3xM3 @ 120°
H13		42.0 mm 3xM3 @ 120°
H14	0	48.0 mm 4xM3 @ 90°
H15		57.5 mm 4xM3 @ 90°
H16		65.0 mm 4xM3 @ 90° (Fan Hole)

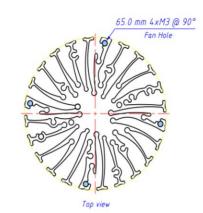






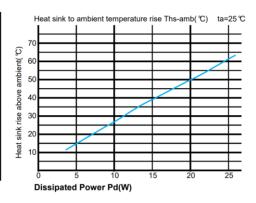




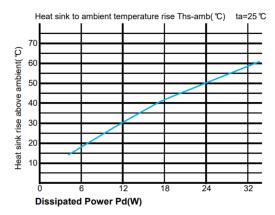


Thermal Data SPIRLED-7050

	= Pe x 1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (℃/W)	Heat sink to ambient temperature rise Ths-amb (℃)	
Г	5	3	15	
Pd(W)	10	2.7	27	
Dissipated Power Pd(W)	15	2.6	39	
ated P	20	2.5	50	
Dissip	25	2.44	61	
Ĺ		·		



	= Pe x 1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (°C/W)	riout onlic to dillibion
Г	6	3	18
Pd(W)	12	2.5	30
Dissipated Power Pd(W)	18	2.28	41
ated P	24	2.08	50
Dissip	32	1.84	59
	·		

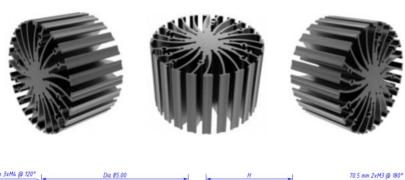


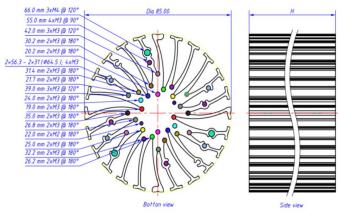
85mm Diameter

WKV Part Number	Description	Height (mm)	Diameter (mm)	Max. Lumen (lm)	Dissipated Power (W)	Thermal Resistance (°C/W)	Weight (g)
SPIRLED-8550	SPIR LED Heat Sink 85MM DIA 50H	50	85	4700	34	2.2	286
SPIRLED-8580	SPIR LED Heat Sink 85MM DIA 80H	80	85	5300	38	1.8	458

*Note: All Bases Have no Holes

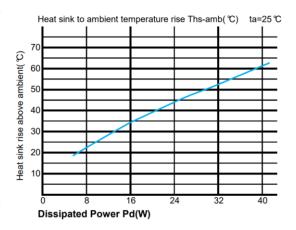
No.	Finish	Mounting Hole
A1		19.0 mm 2xM3 @ 180°
A2	0	20.2 mm 2xM3 @ 180°
A3	•	21.7 mm 2xM3 @ 180°
A4	•	22.0 mm 2xM2 @ 180°
A5	•	24.0 mm 2xM3 @ 180°
A6	0	25.0 mm 2xM3 @ 180°
A7	•	26.2 mm 2xM3 @ 180°
A8	0	26.8 mm 2xM3 @ 180°
A9	0	30.2 mm 2xM3 @ 180°
A10	0	31.4 mm 2xM3 @ 180°
A11	•	32.2 mm 2xM3 @ 180°
A12	•	35.0 mm 2xM3 @ 180°
A13	•	39.0 mm 3xM3 @ 120°
A14	•	42.0 mm 3xM3 @ 120°
A15	•	55.0 mm 4xM3 @ 90°
A16	•	2*56.3 - 2*31 (Ø64.5); 4xM3
A17		66.0 mm 3xM4 @ 120°
A18	•	70.5 mm 2xM3 @ 180° (Fan Hole)



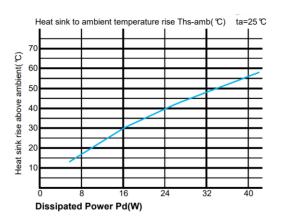


Thermal Data SPIRLED-8550

	= Pe x 1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (℃/W)	Heat sink to ambient temperature rise Ths-amb (°C)
Г	8	2.88	23
Pd(W)	16	2.19	35
Dissipated Power Pd(W)	24	1.88	45
ated P	32	1.66	53
Dissip	40	1.53	61
L			



	= Pe x 1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (*℃/W)	Heat sink to ambient temperature rise Ths-amb (℃)	
П	8	2.25	18	
Dissipated Power Pd(W)	16	16 1.88	30	
ower	24	1.67	40	
ated P	32	1.5	48	
Dissip	40 1.4		56	
L				



96mm Diameter

				Diameter		Dissipated	Thermal Resistance (
	WKV Part Number	mber Description	Height (mm)	(mm)	Max. Lumen (lm)	Power (W)	°C/W)	Weight (g)
SPIRLED-9650 SPIR LED Heat Sink 96MM DIA 50H 50 96 5200 37.5 1.2	SPIRLED-9650	SPIR LED Heat Sink 96MM DIA 50H	50	96	5200	37.5	1.2	360
SPIRLED-9680 SPIR LED Heat Sink 96MM DIA 80H 80 96 6800 49.2 0.9 5	SPIRLED-9680	SPIR LED Heat Sink 96MM DIA 80H	80	96	6800	49.2	0.9	575

No. Finish Mounting Hole H1 18.5 mm 2xM3 @ 180° H2 19.0 mm 2xM3 @ 180° НЗ 24.0 mm 2xM3 @ 180° 25.0 mm 2xM3 @ 180° 26.2 mm 2xM3 @ 180° 26.8 mm 2xM3 @ 180° H7 31.4 mm 2xM3 @ 180° H8 32.2 mm 2xM3 @ 180° H9 35.0 mm 2xM3 @ 180° 39.0 mm 3xM3 @ 120° 42.0 mm 3xM3 @ 120° H11 0 H12 43.0 mm 4xM3 @ 90°

H13 •

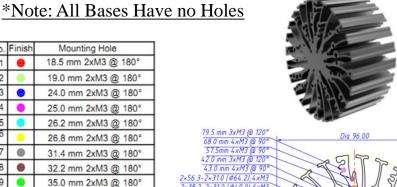
H14 •

H16

H17

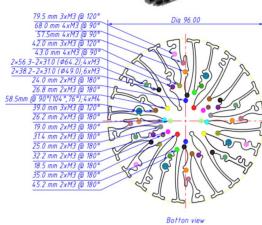
H18

H19

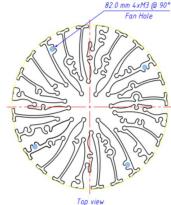












Thermal Data SPIRLED-9650

45.2 mm 2xM3 @ 180°

2*38.2-2*31.0 (Ø49.0);6xM3

57.5mm 4xM3 @ 90°

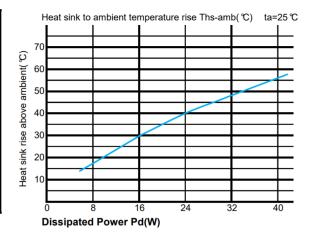
58.5mm @ 90°(104°,76°);4xM4

2*56.3-2*31.0 (Ø64.2);4xM3

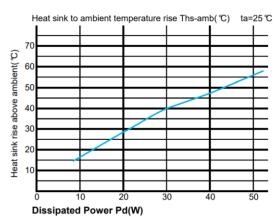
68.0 mm 4xM3 @ 90° 79.5 mm 3xM3 @ 120°

82.0 mm 4xM3 @ 90 (Fan Hole)

_			
	= Pe x 1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (℃/W)	Heat sink to ambient temperature rise Ths-amb (で)
	8	2.25	18
Pd(W)	16	1.88	30
ower	24	1.67	18
ated P	32	1.5	48
Dissipated Power Pd(W)	40	1.4	56

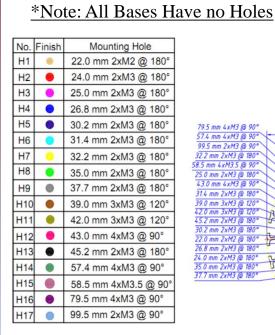


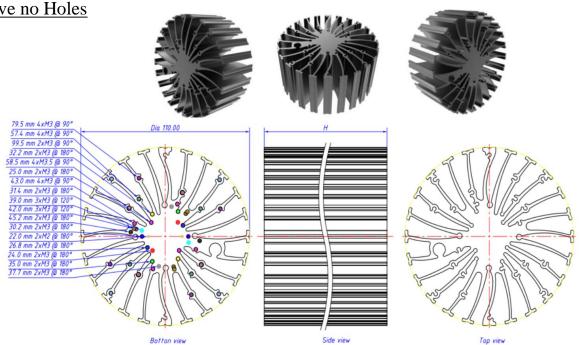
	= Pe x 1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (°C/W)	Heat sink to ambient temperature rise Ths-amb (°C)
	10	1.7	17
Pd(W)	20	1.45	29
Dissipated Power Pd(W)	30	1.33	40
ated P	40	1.2	48
Dissip	50 1.12		56



110mm Diameter

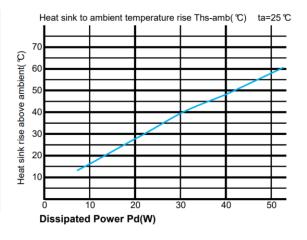
		Height		Max. Lumen		Thermal Resistance (Weight
WKV Part Number	Description	(mm)	Diameter (mm)	(lm)	Dissipated Power (W)	°C/W)	(g)
SPIRLED-11050	SPIR LED Heat Sink 110MM DIA 50H	50	110	6700	48	1.1	414
SPIRLED-11080	SPIR LED Heat Sink 110MM DIA 80H	80	110	7900	57	0.9	662



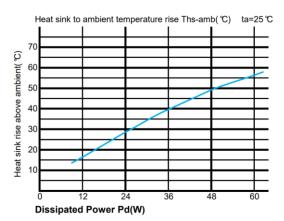


Thermal Data SPIRLED-11050

Pd ((1-nl) ther	= Pe x Heat sink to ambient thermal resistance Rhs-amb (℃/W)		Heat sink to ambient temperature rise Ths-amb(℃)
П	10	1.6	16	
(W)pc	20	20 1.4	28	
ower	30	1.33	40	
ated P	40	1.23	49	
Dissip	50	1.16	58	
	·			



	= Pe x 1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (°C/W)	Heat sink to ambient temperature rise Ths-amb (°C)
	12	1.33	16
(W)Pd	24	1.21	29
Dissipated Power Pd(W)	36	1.11	40
ated P	48	1.03	49.5
Dissip	60 0.95		57



Wakefield- Vette's STRTLED radial aluminum extrusion that makes the convection heat dissipation reasonable. This is compatible with Light Modules such as Edison, Xicato, Bridgelux, Osram, Lumileds, Cree, Tridonic, LG, Lustrous, Prolight, Samsung, SHARP, Luminus and Philips.

Features:

- Mechanical compatibility with direct mounting of the LED modules to the LED cooler and thermal performance matching the lumen packages
- Several Diameters, Several Standard heights
- Extruded from highly conductive aluminum
- Black Anodized
- Blank surface with no holes to mount any device listed below

Compatible with:

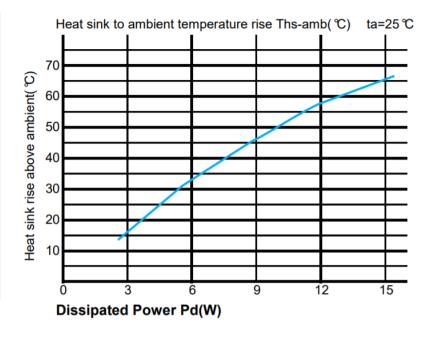
- Xicato XSM, XIM,XTM
- Bridgelux ESS, ESR, Vero 10, Vero 13, Vero 18 V-series
 - Citizen CLL024-CLU028, CLL034-CLU038
 - Cree XLamp CXA13xx, CXA15xx, CSA18xx
- Lumileds Luxeon COB's 1203, 1204, 1205, Luxeon K arrays K12, K16
 - Osram PrevaLED Core, SOLERIQ P and SOLERIQ S LED engines
 - Seoul Semiconductor ZC6, ZC12, ZC18, ZC25
 - Tridonic TALEXXmodule SLE modules
 - LG Innotek LEMWM18 10W, 13W, 17W
 - Edison EdiLex SLM and EdiLex II COB LED engines
 - Lustrous LUSTRON 6 series LL604F, LL608D, LL613F, LL620F
 - Prolight Opto PABS, PABA, PACB, PANA
 - Samung LC013, LC019, LC026 COB LED engines
 - SHARP Mini Zenigata Intermo and Mega Zenigata LED engines
 - Philips Fortimo SLM LED engines
 - Vossloh-Schwabe LUGA Shop LED engines
 - Luminus C##9, C##14 LED engines



46mm Diameter

				D : 1		D: : : 1D			
WKV F	Part Num	per Description	Height (mm)	Diameter (mm)	Max. Lumen (lm)	Dissipated Power (W)	Thermal Resistance (°C/W)	Weight (g)	
STR	TLED-465	STRT LED Heat Sink 46MM DIA 50H	50	46	1400	10	5	101	
*	Note	e: All Bases Have no) Holes						
No.	Finish	Mounting Hole							
A1		17.0 mm 2xM3 @ 180°							
A2		19.0 mm 2xM3 @ 180°			42.0 mm	3xM3 @ 120°			
А3	0	21.7 mm 2xM3 @ 180°				2xM3 @ 180° 2xM3 @ 180°	-	Н	
A4		22.0 mm 2xM3 @ 180°	19.0 mm 2xM3 @ 180° 22.0 mm 2xM3 @ 180° 25.0 mm 2xM3 @ 180° 26.8 mm 2xM3 @ 180° 26.8 mm 2xM3 @ 180°						
A5		24.0 mm 2xM3 @ 180°							
A6		25.0 mm 2xM3 @ 180°	31.4 mm 2xM3 @ 180°			Miles			
A7		26.0 mm 2xM3 @ 180°	39.0 mm 3xM3 @ 120° —	man, i	.vinn				
A8		26.8 mm 2xM3 @ 180°							
A9		31.4 mm 2xM3 @ 180°	Botton view (01) Botton view (02)						
A10	•	35.0 mm 2xM3 @ 180°							
A11		39.0 mm 3xM3 @ 120°		5017011				Side view	
A12	•	42.0 mm 3xM3 @ 120°							

	= Pe x 1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (℃/W)	Heat sink to ambient temperature rise Ths-amb (℃)		
	3	5.67	17		
Pd(W)	6	5.5	33		
ower	9	5.22	47		
ated P	12	4.83	58		
Dissipated Power Pd(W)	15	4.33	65		



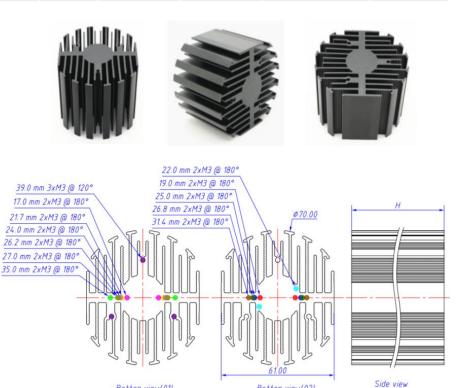
70mm Diameter

			Diameter		Dissipated Power		
WKV Part Number	Description	Height (mm)	(mm)	Max. Lumen (Im)	(W)	Thermal Resistance (°C/W)	Weight (g)
STRTLED-7050	STRT LED Heat Sink 70MM DIA 50H	50	70	3200	22.9	2.1	206

Botton view(01)

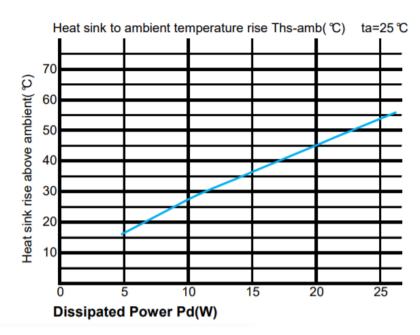
*Note: All Bases Have no Holes

No.	Finish	Mounting Hole
A1	0	17.0 mm 2xM3 @ 180°
A2		19.0 mm 2xM3 @ 180°
A3	0	21.7 mm 2xM3 @ 180°
A4		22.0 mm 2xM3 @ 180°
A5	9	24.0 mm 2xM3 @ 180°
A6	•	25.0 mm 2xM3 @ 180°
A7	•	26.2 mm 2xM3 @ 180°
A8	•	26.8 mm 2xM3 @ 180°
A9	0	27.0 mm 2xM3 @ 180°
A10	0	31.4 mm 2xM3 @ 180°
A11	•	35.0 mm 2xM3 @ 180°
A12	•	39.0 mm 3xM3 @ 120°



Thermal Data STRTLED-7050

	= Pe x 1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (°C/W)	Heat sink to ambient temperature rise Ths-amb (℃)	
	5	3.4	17	
Pd(W)	10	2.8	28	
Dissipated Power Pd(W)	15	2.7	37	
ated P	20	2.25	45	
Dissip	25	2.16	54	
		_	_	



Botton view(02)

95mm Diameter

1444					Diameter		Dissipated Power	TI 15 : (86/44)	M : 1 : / N
	V Part N FRTLED-9			Height (mm) 50	(mm) 95	Max. Lumen (lm) 5600	(W) 40.5	Thermal Resistance (°C/W) 1.25	Weight (g) 353
*	Not	e: All Bases Ha	ive no I	<u>Holes</u>					MA
No.	Finish	Mounting Hole				111		lili Illiha	HIII
A1	•	19.0 mm 2xM3 @ 180°			ilkh. di				HILL
A2	0	21.7 mm 2xM3 @ 180°			'Ullill				nn
A3	0	22.0 mm 2xM3 @ 180°			4000	100			
A4		24.0 mm 2xM3 @ 180°					-		
A5	•	25.0 mm 2xM3 @ 180°		Botton view(01)		Botton view(0	02)		
A6	•	26.2 mm 2xM3 @ 180°	22.0 1	тт 2xM3 @ 180°					44
A7	0	26.8 mm 2xM3 @ 180°	-	m 2xM3 @ 180°			тт 2хМ3 @ 180°	Ø95.00	H
A8	•	27.0 mm 2xM3 @ 180°	_	m 2xM3 @ 180° 2xM3 @ 180°	TOPS		nm 2xM3 @ 180° n 3xM3 @ 120°	To Top	
A9	0	30.2 mm 2xM3 @ 180°		хМЗ @ 180°		27.0 mm	n 2xM3 @ 180°		
A10	•	31.4 mm 2xM3 @ 180°	33.0 mm 2xi 45.0 mm 2xi	N 11/11		11 11 11	п 2xM3 @ 180° п 2xM3 @ 180°		
A11	0	33.0 mm 2xM3 @ 180°	35.0 mm 2xM	JI M 11 112	MANIE	33.3 mm	n 2xM3 @ 180°		
A12	•	33.3 mm 2xM3 @ 180°	39.0 mm 3xM	13 @ 120°			n 2xM3 @ 180°		
A13	•	35.0 mm 2xM3 @ 180°					8	F1 (8)	
A14	0	37.7 mm 2xM3 @ 180°							
A15	0	45.0 mm 2xM3 @ 180°		00		10/	8011		

Botton view(01)

Thermal Data STRTLED-9550

45.2 mm 2xM3 @ 180° 39.0 mm 3xM3 @ 120°

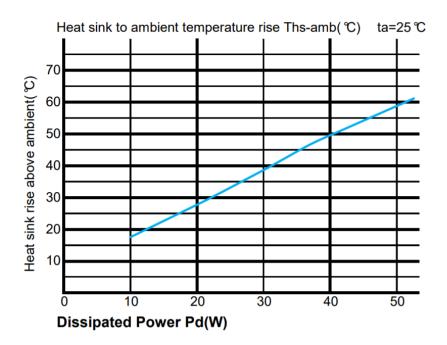
42.0 mm 3xM3 @ 120°

A16

A17

A18

	= Pe x 1-ηL)	Heat sink to ambient thermal resistance Rhs-amb (°C/W)	Heat sink to ambient temperature rise Ths-amb (℃)	
	10	1.8	18	
Pd(W)	20	1.4	28	
Dissipated Power Pd(W)	30	1.3	39	
ated P	40	1.25	50	
Dissip	50	1.18	59	



Botton view(02)

Side view

THERMAL SELECTION GUIDELINES

CUSTOM RADIAL-FIN HEAT SINKS BRIDGELUX LED Light Engines

Background:

Continued growth of BRIDGELUX LED lighting products has created a very real need for design and usage guidelines aimed specifically at helping engineers and designers select heat sink products based on both space constraints and operating parameters.

WAKEFIELD SOLUTIONS has been working in conjunction with BRIDGELUX to develop a new product line of Custom Radial-Fin Heat Sinks – designed specifically for the complete family of BRIDGELUX LED Light Engines being marketed through NEWARK element 14.

Summary Table 1:

	BRIDGELUX P/N	Form factor	ORDERABLE P/N	HS Length	Thermal	HS TR	T RISE
				(in)	(W)	(C/W)	(C)
1	BXRA-N3500-00000	RS Rectangle	19754-M-AB	7.50	23.3	0.68	15.9
	BXRA-C4500-00000	RS Rectangle	19754-M-AB	7.50	34.5	0.68	23.5
	BXRA-W3000-00000	RS Rectangle	19754-M-AB	7.50	42.8	0.68	29.2
2	BXRA-C0802-00000	Rectangle	19755-S-AB	2.75	11.3	2.20	24.7
3	BXRA-W0802-00000	Rectangle	19755-M-AB	4.00	15.0	1.82	27.3
4	BXRA-W1202-00000	Rectangle	19755-L-AB	6.00	18.8	1.49	27.9
5	BXRA-W1203-00000	Rectangle	19755-XL-AB	8.00	22.5	1.29	29.0
6	BXRA-C2002-00000	Rectangle	19755-XXL-AB	10.00	26.3	1.15	30.2
	BXRA-C1202-00000	Rectangle	19755-M-AB	4.00	15.0	1.82	27.3
	BXRA-N0802-00000	Rectangle	19755-M-AB	4.00	15.0	1.82	27.3
	BXRA-N1203-00000	Rectangle	19755-XL-AB	8.00	22.5	1.29	29.0
7	BXRA-C0402-0000	Star	19756-S-AB	2.00	4.1	3.03	12.5
8	BXRA-W0402-0000	Star	19756-M-AB	2.75	5.6	2.48	13.9
9	BXRA-W0401-0000	Star	19756-L-AB	3.00	7.5	2.59	19.4
10	BXRA-W0403-00000	Star	19756-XL-AB	3.25	9.0	2.38	21.4
	BXRA-C0603-00000	Star	19756-XL-AB	3.25	9.0	2.38	21.4
11	BXRA-W0260-00000	LS	19757-S-AB	2.75	3.0	3.55	10.7
12	BXRA-C0360-00000	LS	19757-M-AB	3.00	3.8	3.40	12.8
13	BXRA-C0361-00000	LS	19757-L-AB	3.25	4.5	3.27	14.7
	BXRA-W0261-00000	LS	19757-S-AB	2.75	3.0	3.55	10.7
	BXRA-W0240-00000	LS	19757-M-AB	3.00	3.8	3.40	12.8
	BXRA-W0241-00000	LS	19757-L-AB	3.25	4.5	3.27	14.7
14	Helieon 1200LM	Helieon	19758-M-AB	7.00	24.0	1.15	27.7

Note – although there are 23 specific BRIDGELUX LED light options – there are only 14 Custom Wakefield Solutions Rad-Fin Heat Sink part numbers required to support the complete product line.

The Orderable P/Ns are made up of the unique extrusion profile number, followed by the product length, (i.e. S=Short. M=Medium, L=Length etc...), and finally the finish designation, (AB=Anodized Black).

The last column "T Rise" contains the estimated temperature rise above ambient, (i.e. room temperature), for a given WAKEFIELD Radial-Fin Heat Sink assembled with the associated BRIDGELUX LED. These values – T Rise and T Ambient - are added to determine the estimated LED Substrate temperature.

All WAKEFIELD Rad-Fin Heat Sink Lengths were derived using this T Rise with a T Ambient with a standard T Ambient of 40 degrees C maximum – with the objective to yield a maximum LED Substrate temperature of 70 degrees C or less.

This 70 degrees C maximum LED Substrate operating temperature has been specified by BRIDGELUX as the highest temperature permissible to achieve the expected LED light quality, (full lumens), for the extended life of 50.000 hours.

Sample Calculations:

To calculate the expected LED Substrate Temperature using a specific Rad-Fin Heat Sink ...

Select the Rad-Fin Heat Sink in Summary Table 1 ... go across to the columns to the second column in from the right – HS TR (C/W) – this column indicates the Heat Sink Thermal Resistance Values for each specific heat sink – in degrees Centigrade Temperature Rise per Watt of Thermal Load (W) in Natural Convection, (no fan).

Next ... look at the value in the third column from the right – THERMAL (W) – this is he Maximum Thermal Load Value for the specific BRIDGELUX LED.

The product of multiplying these two values – is the expected temperature rise above ambient for the particular LED Substrate and Heat Sink combination:

T Rise Values are found in the first column from the right in Summary Table 1.

For BRIDGELUX LED BXRA-W0802-00000 - WAKEFIELD Rad-Fin Heat Sink 19755-M-AB:

Table 2:

Γ							HS	HS			
		BRIDGELUX	SERIES	ORDERABLE	HS Length	HS Length	Diameter	Diameter	Thermal	HS TR	T RISE
		P/N		P/N	(in)	(mm)	(in)	(mm)	(W)	(C/W)	(C)
	з Вх	RA-W0802-00000	Rectangle	19755-M-AB	4	101.6	2.5	63.5	15	1.82	27.3

HS TR (C/W) X THERMAL (W) = T Rise (C)

1.82 C/W X 15 W = 27.3 C T Rise above Ambient Temperature

NOTE: BRIDGELUX has chosen 40 degrees C as the maximum expected Ambient Temperature – the "Standard" Rad-Fin Heat Sink Lengths indicated in Summary Table 1 were determined based on this 40 C Max Ambient Temperature and "Specified" 70 C Max LED Substrate Temperature.

Therefore, the LED Substrate Max Temperature is the Sum of:

Max T Rise + Max T Ambient = Max LED Substrate Temperature

27.3 C T Rise + 40 C T Ambient = 67.3 C T LED Substrate Temperature

Can shorter length Rad-Fin Heat Sinks be used successfully?

YES - assuming the Maximum Ambient temperature is less than 40 degrees C - a shorter length heat sink within the same product family can be substituted.

Example:

In the case where Max T Ambient is expected to be less than 40 C – for example - assuming a Max T Ambient of 35 C – it would be possible to use a shorter length Rad-Fin Heat Sink.

Could the "next size down" Rad-Fin Heat Sink - 19755-S-AB - be used?

HS TR (C/W) X THERMAL (W) = T Rise (C)

2.2 C/W X 15 W = 33 C T Rise above Ambient Temperature

Therefore, the LED Substrate Max Temperature is the Sum of:

Max T Rise + Max T Ambient = Max LED Substrate Temperature

33 C T Rise + 35 C T Ambient = 68 C T LED Substrate Temperature

Example Summary:

Five Rad-Fin Heat Sink Lengths were manufactured for the BRIDGELUX "Rectangular" Form Factor LED Light Engine Family;

- 1. **S** = **Short**
- 2. M= Medium
- 3. L= Long
- 4. XL= Extra Long
- 5. XXL = Extra Extra Long

Summary Table 3:

BRIDGELUX P/N	Form	ORDERABLE	HS	T SUB	ORDERABLE	T SUB
	Factor	P/N	Length	40C Amb	P/N	35C Amb
			(in)	(C)		(C)
BXRA-C0802-00000	Rectangle	19755-S-AB	2.75	64.86	19755-S-AB	59.86
BXRA-W0802-00000	Rectangle	19755-M-AB	4	<mark>67.30</mark>	19755-S-AB	68.00
BXRA-W1202-00000	Rectangle	19755-L-AB	6	68.01	19755-M-AB	69.22
BXRA-W1203-00000	Rectangle	19755-XL-AB	8	69.03	19755-L-AB	73.53
BXRA-C2002-00000	Rectangle	19755-XXL-AB	10	70.25	19755-XL-AB	68.93
BXRA-C1202-00000	Rectangle	19755-M-AB	4	67.30	19755-S-AB	68.00
BXRA-N0802-00000	Rectangle	19755-M-AB	4	67.30	19755-S-AB	68.00
BXRA-N1203-00000	Rectangle	19755-XL-AB	8	69.03	19755-L-AB	68.53

From the previous example BXRA-W0802-00000 - WAKEFIELD Rad-Fin Heat Sink 19755-M-AB:

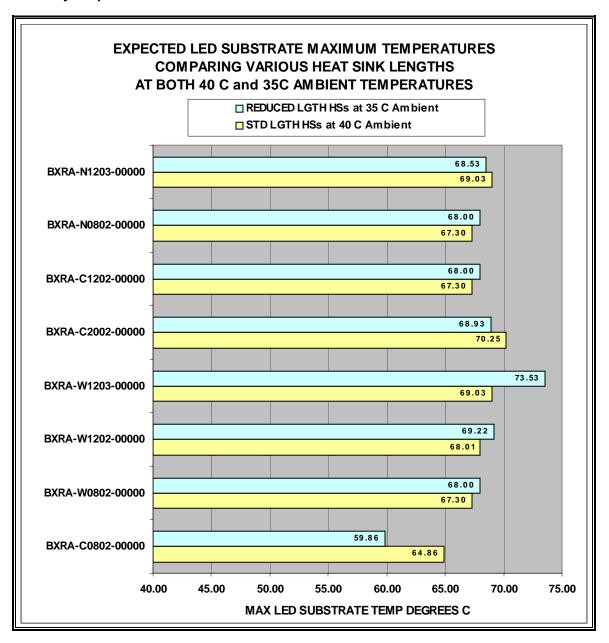
The first temperature column -

 T SUB 40C Amb – indicates the LED Substrate temperatures for the "Standard" length heat heats at 40 C Ambient Temperature = 67.3 C.

The second temperature column -

 T SUB 35C Amb – indicates the LED Substrate temperatures for the "Reduced" length heat sinks at 35 C Ambient Temperature = 68.0 C.

Summary Graph 1:



Conclusion:

This Summary Graph 1 overview of the - WAKEFIELD 19755 Rad-Fin Heat Sink Profile - indicates that for all products except BXRA-W1203-0000 – it would be possible to use the "next size down" length Rad-Fin Heat Sink if the Max T Ambient is reduced from the specified 40 C to 35 C and still maintain a Max T Substrate below the BRIDGELUX specified 70 C Maximum.

Knowing the specific values from Summary Table 1:

- Heat Sink Thermal Resistance Values HS TR (C/W)
- LED Thermal Load THERMAL (W)

The Temperature Rise – Max T Rise (C) – can be calculated.

By adding this Max T Rise to the Max Ambient Temperature the Max LED Substrate Temperature can be estimated – this will enable the selection of the minimum size Rad-Fin Heat Sink for a specific application.

Max T Rise (C) + Max T Ambient (C) = Max T LED Substrate